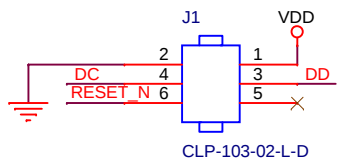
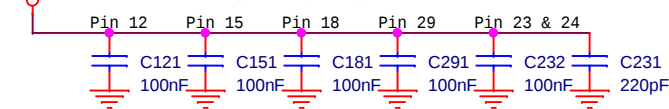
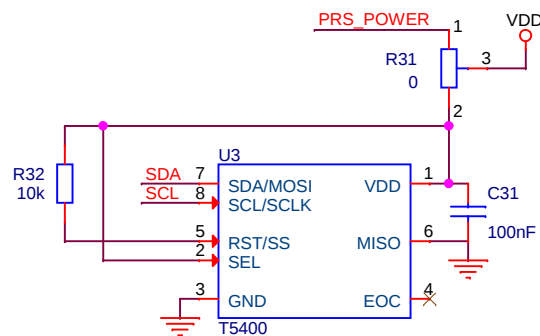
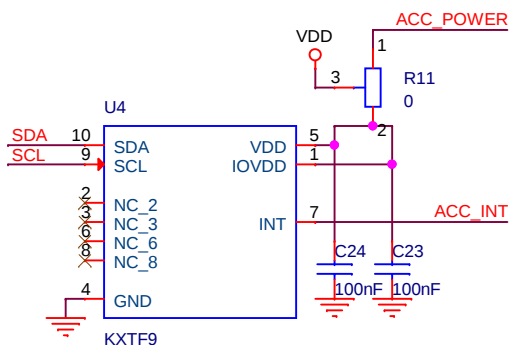
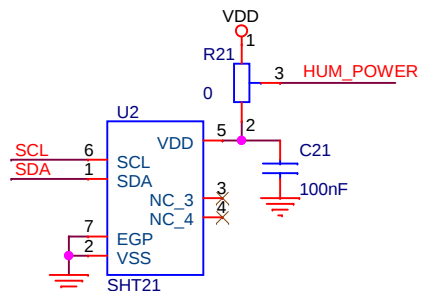
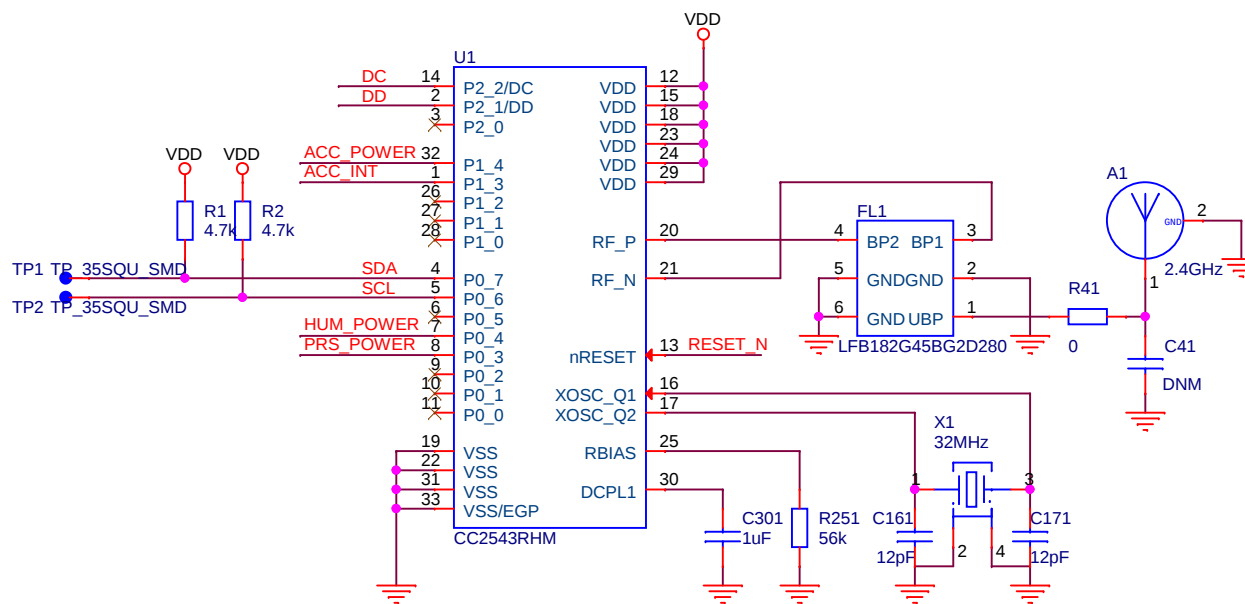


Place decoupling capacitors close to Vdd pins:



Note:
Non-standard
debug interface



Title: Mini Bluetooth Low Energy Broadcaster		TEXAS INSTRUMENTS	
Drawn: FGK			
Checked: NN			
Size: A4	Rev: 1.0.0	Sheet: 1 of 1	
Date: Tuesday, June 24, 2014			

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